

MMSD4148, SMMSD4148

スイッチング ダイオード

特長

- SOD-123面実装パッケージ
- 高耐圧
- 高速スイッチングタイム
- Sで始まる製品番号は特有の工場および変更管理を必要とする車載およびその他の用途に対応; AEC-Q101認定, PPAP対応可*
- 鉛フリー、ハロゲンフリーおよびBFRフリー対応、RoHS準拠

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Continuous Reverse Voltage	V_R	100	V
Forward Current	I_F	200	mA
Forward Surge Current (Note 1)	I_{FSM}	1.0 2.0	A
Repetitive Peak Forward Current (Pulse Wave = 1 sec, Duty Cycle = 66%)	I_{FRM}	0.5	A
Operating and Storage Junction Temperature Range	T_J, T_{stg}	-55 to +150	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

(参考訳)

最大定格を超えるストレスは、デバイスにダメージを与える危険性があります。これらの定格値を超えた場合は、デバイスの機能性を損ない、ダメージが生じたり、信頼性に影響を及ぼす危険性があります。

1. Typical Values

THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Total Device Dissipation FR-5 Board (Note 2) $T_A = 25^\circ\text{C}$ Derate above 25°C	P_D	425 3.4	mW mW/°C
Thermal Resistance Junction-to-Ambient	$R_{\theta JA}$	290	°C/W

2. FR-5 = 1.0 oz Cu, 1.0 in² pad



ON Semiconductor®

www.onsemi.com



SOD-123
CASE 425
STYLE 1



MARKING DIAGRAM



5I = Device Code
M = Date Code
▪ = Pb-Free Package

(Note: Microdot may be in either location)

ORDERING INFORMATION

Device	Package	Shipping†
MMSD4148T1G	SOD-123 (Pb-Free)	3,000 / Tape & Reel
SMMSD4148T1G*	SOD-123 (Pb-Free)	3,000 / Tape & Reel
MMSD4148T3G	SOD-123 (Pb-Free)	10,000 / Tape & Reel
SMMSD4148T3G*	SOD-123 (Pb-Free)	10,000 / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

ELECTRICAL CHARACTERISTICS ($T_A = 25^\circ\text{C}$ unless otherwise noted)

Characteristic	Symbol	Min	Max	Unit
OFF CHARACTERISTICS				
Reverse Breakdown Voltage ($I_{BR} = 100\ \mu\text{A}$)	$V_{(BR)}$	100	–	V
Reverse Voltage Leakage Current ($V_R = 20\ \text{V}$) ($V_R = 75\ \text{V}$)	I_R	– –	25 5.0	nA μA
Forward Voltage ($I_F = 10\ \text{mA}$)	V_F	–	1000	mV
Diode Capacitance ($V_R = 0\ \text{V}$, $f = 1.0\ \text{MHz}$)	C_D	–	4.0	pF
Reverse Recovery Time ($I_F = I_R = 10\ \text{mA}$) (Figure 1)	t_{rr}	–	4.0	ns

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

(参考訳)

製品パラメータは、特別な記述が無い限り、記載されたテスト条件に対する電気的特性で示しています。異なる条件下で製品動作を行った時には、電気的特性で示している特性を得られない場合があります。

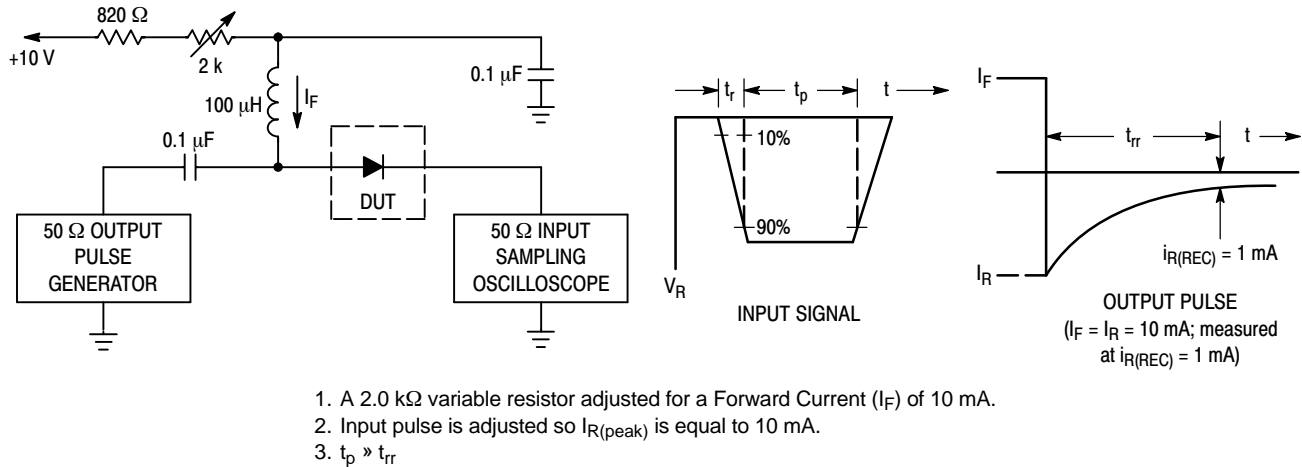


Figure 1. Recovery Time Equivalent Test Circuit

MMSD4148, SMMSD4148

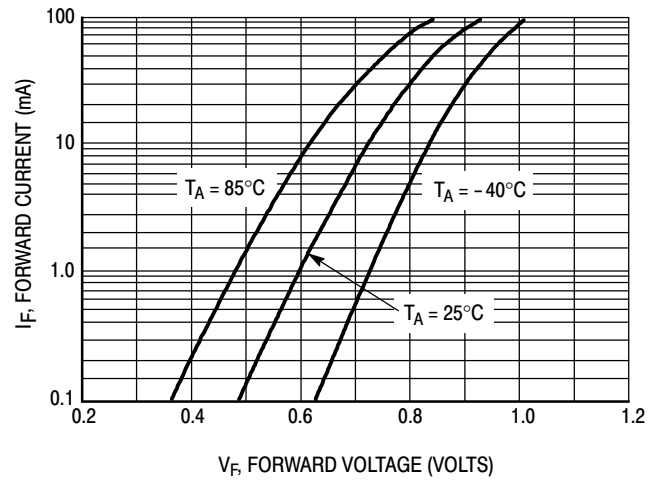


Figure 2. Forward Voltage

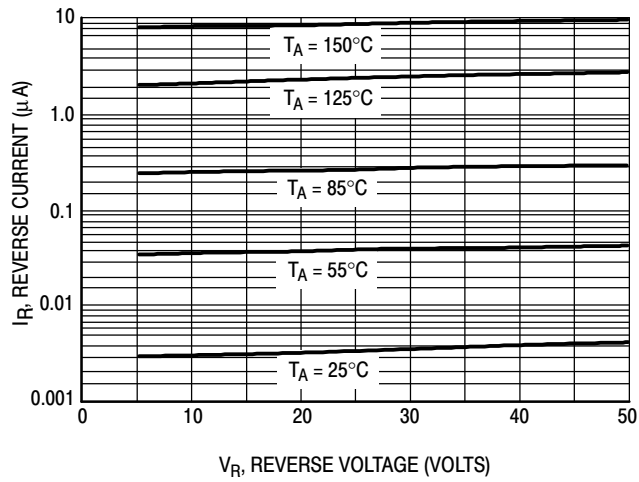


Figure 3. Leakage Current

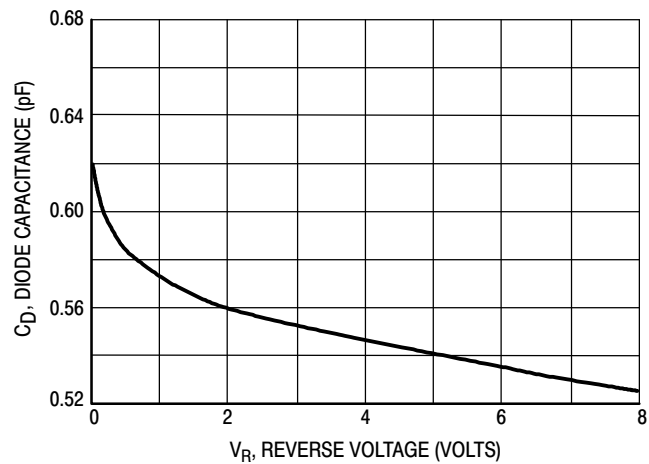
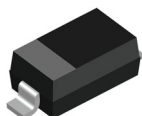


Figure 4. Capacitance


onsemi[™]

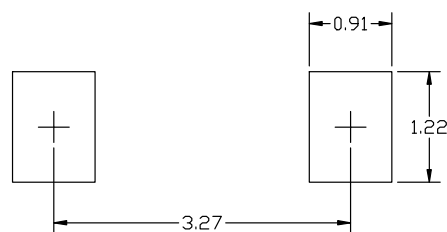
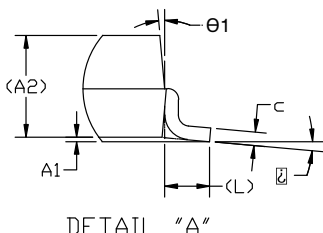
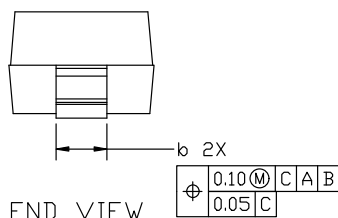
ISSUE H

DATE 29 FEB 2024



1. DIMENSION AND TOLERANCING PER ASME Y14.5M, 2018
2. CONTROLLING DIMENSION: MILLIMETERS

	MILLIMETER		
DIM	MIN.	NOM.	MAX.
A	0.94	1.17	1.35
A1	0.00	0.05	0.10
A2	1.16 REF.		
b	0.51	0.61	0.71
c	—	—	0.15
D	1.40	1.60	1.80
E	2.54	2.69	2.84
H	3.56	3.68	3.86
L	0.25 REF.		
	0°		10°
Ø1	0°		10°



- = Pb-Free Package

(Note: Microdot may be in either location)

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "•", may or may not be present. Some products may not follow the Generic Marking.

STYLE 1:
PIN 1. CATHODE
2. ANODE

*For additional information on or Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference manual [SOLDERM/D](http://www.onsemi.com/SOLDERM/D).

DOCUMENT NUMBER:	98ASB42927B	Electronic versions are uncontrolled except when accessed directly from the Document Repository. Printed versions are uncontrolled except when stamped "CONTROLLED COPY" in red.
DESCRIPTION:	SOD-123 2L 1.60x2.69x1.16	PAGE 1 OF 1

onsemi and **onsemi** are trademarks of Semiconductor Components Industries, LLC dba **onsemi** or its subsidiaries in the United States and/or other countries. **onsemi** reserves the right to make changes without further notice to any products herein. **onsemi** makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does **onsemi** assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. **onsemi** does not convey any license under its patent rights nor the rights of others.

onsemi, **Onsemi**, and other names, marks, and brands are registered and/or common law trademarks of Semiconductor Components Industries, LLC dba "**onsemi**" or its affiliates and/or subsidiaries in the United States and/or other countries. **onsemi** owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of **onsemi**'s product/patent coverage may be accessed at www.onsemi.com/site/pdf/Patent-Marking.pdf. **onsemi** reserves the right to make changes at any time to any products or information herein, without notice. The information herein is provided "as-is" and **onsemi** makes no warranty, representation or guarantee regarding the accuracy of the information, product features, availability, functionality, or suitability of its products for any particular purpose, nor does **onsemi** assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using **onsemi** products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by **onsemi**. "Typical" parameters which may be provided in **onsemi** data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. **onsemi** does not convey any license under any of its intellectual property rights nor the rights of others. **onsemi** products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use **onsemi** products for any such unintended or unauthorized application, Buyer shall indemnify and hold **onsemi** and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that **onsemi** was negligent regarding the design or manufacture of the part. **onsemi** is an Equal Opportunity/Affirmative Action Employer. This literature is subject to all applicable copyright laws and is not for resale in any manner.

ADDITIONAL INFORMATION

TECHNICAL PUBLICATIONS:

Technical Library: www.onsemi.com/design/resources/technical-documentation
onsemi Website: www.onsemi.com

ONLINE SUPPORT: www.onsemi.com/support

For additional information, please contact your local Sales Representative at
www.onsemi.com/support/sales